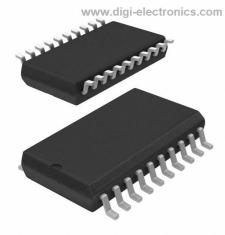


BTS728L2 Datasheet



DiGi Electronics Part Number Manufacturer Manufacturer Product Number Description Detailed Description

BTS728L2-DG

Infineon Technologies

BTS728L2

IC PWR SWITCH N-CHAN 1:1 PDSO-20

Power Switch/Driver 1:1 N-Channel 3.6A PG-DSO-2 0-9

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Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
BTS728L2	Infineon Technologies
Series:	Product Status:
PROFET®	Obsolete
Switch Type:	Number of Outputs:
General Purpose	2
Ratio - Input:Output:	Output Configuration:
1:1	High Side
Output Type:	Interface:
N-Channel	On/Off
Voltage - Load:	Voltage - Supply (Vcc/Vdd):
4.75V ~ 41V	Not Required
Current - Output (Max):	Rds On (Typ):
3.6A	50mOhm
Input Type:	Features:
Non-Inverting	Status Flag
Fault Protection:	Operating Temperature:
Current Limiting (Fixed), Open Load Detect, Over Temperature, Over V	/olŧ 4 ĝ£C ~ 150°C (TJ)
Mounting Type:	Supplier Device Package:
Surface Mount	PG-DSO-20-9
Package / Case:	Base Product Number:
20-SOIC (0.295", 7.50mm Width)	BTS728L2

Environmental & Export classification

RoHS Status:	Moisture Sensitivity Level (MSL):
RoHS non-compliant	1 (Unlimited)
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	
8542.39.0001	

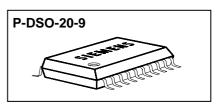


Smart High-Side Power Switch Two Channels: 2 x 60mΩ Status Feedback

Product Summary

Operating Voltage	V _{bb(on)}	4.7541V		
	Active channels	one	two parallel	
On-state Resistance	R _{on}	$60 \text{m}\Omega$	30mΩ	
Nominal load current	I _{L(NOM)}	4.0A	6.0A	
Current limitation	I _{L(SCr)}	17A	17A	





General Description

- N channel vertical power MOSFET with charge pump, ground referenced CMOS compatible input and diagnostic feedback, monolithically integrated in Smart SIPMOS[®] technology.
- Providing embedded protective functions

Applications

- µC compatible high-side power switch with diagnostic feedback for 5V, 12V and 24V grounded loads
- All types of resistive, inductive and capacitve loads
- Most suitable for loads with high inrush currents, so as lamps
- Replaces electromechanical relays, fuses and discrete circuits

Basic Functions

- Very low standby current
- CMOS compatible input
- Improved electromagnetic compatibility (EMC)
- Fast demagnetization of inductive loads
- Stable behaviour at undervoltage
- Wide operating voltage range
- Logic ground independent from load ground

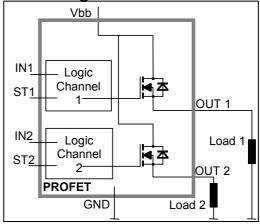
Protection Functions

- Short circuit protection
- Overload protection
- Current limitation
- Thermal shutdown
- Overvoltage protection (including load dump) with external resistor
- Reverse battery protection with external resistor
- Loss of ground and loss of V_{bb} protection
- Electrostatic discharge protection (ESD)

Diagnostic Function

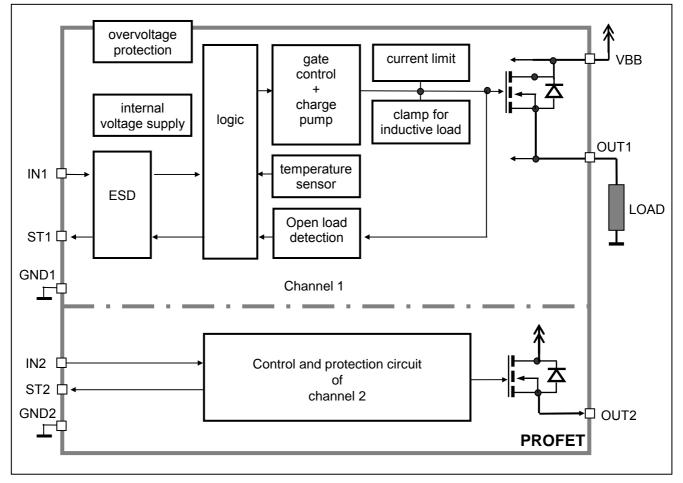
- Diagnostic feedback with open drain output
- Open load detection in ON-state
- Feedback of thermal shutdown in ON-state

Block Diagram





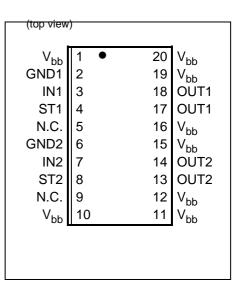
Functional diagram



Pin Definitions and Functions

Pin	Symbol	Function
1,10,	V _{bb}	Positive power supply voltage. Design the
11,12,		wiring for the simultaneous max. short circuit
15,16,		currents from channel 1 to 2 and also for low
19,20		thermal resistance
3	IN1	Input 1,2, activates channel 1,2 in case of
7	IN2	logic high signal
17,18	OUT1	Output 1,2, protected high-side power output
13,14	OUT2	of channel 1,2. Design the wiring for the max.
		short circuit current
4	ST1	Diagnostic feedback 1,2 of channel 1,2,
8	ST2	open drain, low on failure
2	GND1	Ground 1 of chip 1 (channel 1)
6	GND2	Ground 2 of chip 2 (channel 2)
5,9	N.C.	Not Connected

Pin configuration





Maximum Ratings at $T_j = 25^{\circ}$ C unless otherwise specified

Parameter	Symbol	Values	Unit
Supply voltage (overvoltage protection see page 4)	V _{bb}	43	V
Supply voltage for full short circuit protection $T_{j,start} = -40 \dots + 150^{\circ}C$	V _{bb}	24	V
Load current (Short-circuit current, see page 5)	IL.	self-limited	A
Load dump protection ¹) $V_{\text{LoadDump}} = V_A + V_s$, $V_A = 13.5 \text{ V}$ $R_{\text{I}^{2)}} = 2 \Omega$, $t_{\text{d}} = 200 \text{ ms}$; $\text{IN} = \text{low or high}$, each channel loaded with $R_{\text{L}} = 8.0 \Omega$,	V _{Load dump} ³⁾	60	V
Operating temperature range	Tj	-40+150	°C
Storage temperature range	T _{stg}	-55+150	
Power dissipation (DC) ⁴ $T_a = 25^{\circ}$ C:	P _{tot}	3.7	W
(all channels active) $T_a = 85^{\circ}C$:		1.9	
Maximal switchable inductance, single pulse $V_{bb} = 12V$, $T_{j,start} = 150^{\circ}C^{4}$,			
$I_{\rm L}$ = 4.0 A, $E_{\rm AS}$ = 220 mJ, 0 Ω one channel:	ZL	19.9	mH
$I_{\rm L} = 6.0 \text{A}, E_{\rm AS} = 540 \text{mJ}, 0 \Omega$ two parallel channels:		22.3	
see diagrams on page 9			
Electrostatic discharge capability (ESD) IN: (Human Body Model) ST: out to all other pins shorted: acc. MIL-STD883D, method 3015.7 and ESD assn. std. S5.1-1993 R=1.5kΩ; C=100pF	V _{ESD}	1.0 4.0 8.0	kV
Input voltage (DC)	V _{IN}	-10 +16	V
Current through input pin (DC)	/ _{IN}	±2.0	mA
Current through status pin (DC)	I _{ST}	±5.0	
see internal circuit diagram page 8			

Thermal Characteristics

Parameter and Conditions		Symbol	Values			Unit
		_	min	typ	Max	
Thermal resistance						
junction - soldering point ^{4),5)}	each channel:	<i>R</i> thjs			13.5	K/W
junction - ambient ⁴⁾	one channel active:	R _{thja}		41		
	all channels active:			34		

Supply voltages higher than V_{bb(AZ)} require an external current limit for the GND and status pins (a 150Ω resistor for the GND connection is recommended.

²⁾ $R_{\rm I}$ = internal resistance of the load dump test pulse generator

³⁾ V_{Load dump} is setup without the DUT connected to the generator per ISO 7637-1 and DIN 40839

⁴⁾ Device on 50mm*50mm*1.5mm epoxy PCB FR4 with 6cm² (one layer, 70μm thick) copper area for V_{bb} connection. PCB is vertical without blown air. See page 14

⁵⁾ Soldering point: upper side of solder edge of device pin 15. See page 14



Electrical Characteristics

Parameter and Conditions, ea	ch of the two channels	Symbol		Values		Unit
at $T_j = -40+150^{\circ}C$, $V_{bb} = 12$ V unless	s otherwise specified		min	typ	Max	
Load Switching Capabilities a	Ind Characteristics					
On-state resistance (Vbb to OU	T); $I_L = 2 A, V_{bb} \ge 7V$					
each cha	annel, $T_j = 25^{\circ}C$:	R _{ON}		50	60	mΩ
	<i>T</i> _j = 150°C:			100	120	
two parallel ch see diagram, page 10	annels, $T_j = 25^{\circ}C$:			25	30	
Nominal load current	one channel active:	I _{L(NOM)}	3.6	4.0		А
two paral	lel channels active:		5.5	6.0		
Device on PCB ⁶⁾ , $T_a = 85^{\circ}C$, $T_j \le 15^{\circ}$	50°C					
Output current while GND discon Vbb = 30 V, VIN = 0, see diagram pa	• •	I _{L(GNDhigh)}			2	mA
Turn-on time ⁸⁾ IN	to 90% V _{OUT} :	<i>t</i> on	30	100	200	μs
Turn-off time IN	└ to 10% <i>V</i> _{OUT} :	<i>t</i> off	30	100	200	
$R_{\rm L} = 12 \Omega$						
Slew rate on ⁸⁾ 10 to 30% V_{OUT} , $R_{L} = 12 \Omega$	$T_{\rm j} = -40^{\circ}{\rm C}$: $T_{\rm j} = 25^{\circ}{\rm C}150^{\circ}{\rm C}$:	d V/dt _{on}	0.15 0.15		1 0.8	V/µs
Slew rate off ⁸⁾ 70 to 40% V_{OUT} , $R_L = 12 \Omega$	<i>T</i> _j = -40°C: <i>T</i> _j = 25°C150°C:	-dV/dt _{off}	0.15 0.15		1 0.8	V/µs
Operating Parameters		Į		Į		
Operating voltage	Tj=-40	V _{bb(on)}	4.75		41	V
e per anni ger en alge	T ₌ 25150°C:	- 55(61)			43	-
Overvoltage protection ⁹⁾	<i>T</i> _j =-40°C:	V _{bb(AZ)}	41			V
$I_{bb} = 40 \text{ mA}$	<i>T</i> _j =25150°C:	. ,	43	47	52	
Standby current ¹⁰⁾	$T_{\rm j}$ =-40°C25°C:	I _{bb(off)}		10	18	μA
$V_{IN} = 0$; see diagram page 10	<i>T</i> _j =150°C:				50	
Leakage output current (include	ed in I _{bb(off)})	I _{L(off)}		1	10	μA
$V_{\rm IN} = 0$						
Operating current ¹¹), $V_{IN} = 5V$,					. –	
$I_{\rm GND} = I_{\rm GND1} + I_{\rm GND2},$	one channel on: two channels on:	I _{GND}		0.8 1.6	1.5 3.0	mA

⁶⁾ Device on 50mm*50mm*1.5mm epoxy PCB FR4 with 6cm² (one layer, 70μm thick) copper area for V_{bb} connection. PCB is vertical without blown air. See page 14

¹¹⁾ Add I_{ST} , if $I_{ST} > 0$

⁷⁾ not subject to production test, specified by design

⁸⁾ See timing diagram on page 11.

⁹⁾ Supply voltages higher than V_{bb(AZ)} require an external current limit for the GND and status pins (a 150Ω resistor for the GND connection is recommended). See also V_{ON(CL)} in table of protection functions and circuit diagram on page 8.

¹⁰⁾ Measured with load; for the whole device; all channels off



		1			
Parameter and Conditions, each of the two channels	Symbol		Values	i	Unit
at T _j = -40+150°C, V_{bb} = 12 V unless otherwise specified		min	typ	Max	

Protection Functions¹²⁾

Current limit, (see timing diagrams, page 12)					
<i>T</i> _j =-40°C:	I _{L(lim)}	21	28	36	А
7j =25°C:		17	22	31	
<i>T</i> _j =+150°C:		12	16	24	
Repetitive short circuit current limit,					
$T_{\rm j} = T_{\rm jt}$ each channel	I _{L(SCr)}		17		Α
two parallel channels			17		
(see timing diagrams, page 12)					
Initial short circuit shutdown time $T_{j,start} = 25^{\circ}C$:	t _{off(SC)}		2.4		ms
(see timing diagrams on page 12)					
Output clamp (inductive load switch off) ¹³⁾					V
at $V_{ON(CL)} = V_{bb} - V_{OUT}$, $I_L = 40 \text{ mA}$ $T_j = -40^{\circ}\text{C}$:	V _{ON(CL)}	41			
<i>T</i> _j =25°C150°C:		43	47	52	
Thermal overload trip temperature	T _{jt}	150			°C
Thermal hysteresis	ΔT_{jt}		10		K

Reverse Battery

Reverse battery voltage ¹⁴⁾	- V _{bb}	 	32	V
Drain-source diode voltage ($V_{out} > V_{bb}$) $f_L = -4.0 \text{ A}, T_j = +150^{\circ}\text{C}$	- V _{ON}	 600		mV

¹²⁾ Integrated protection functions are designed to prevent IC destruction under fault conditions described in the data sheet. Fault conditions are considered as "outside" normal operating range. Protection functions are not designed for continuous repetitive operation.

¹³⁾ If channels are connected in parallel, output clamp is usually accomplished by the channel with the lowest VON(CL)

¹⁴⁾ Requires a 150 Ω resistor in GND connection. The reverse load current through the intrinsic drain-source diode has to be limited by the connected load. Power dissipation is higher compared to normal operating conditions due to the voltage drop across the drain-source diode. The temperature protection is not active during reverse current operation! Input and Status currents have to be limited (see max. ratings page 3 and circuit page 8).



Parameter and Conditions, each of the two channels	Symbol		Values	;	Unit
at T _j = -40+150°C, V_{bb} = 12 V unless otherwise specified		min	typ	Max	

Diagnostic Characteristics

Open load detection current, (on-condition)				
each channel	I _{L (OL)}	10	 500	mA

Input and Status Feedback¹⁵⁾

Input resistance (see circuit page 8)		Rı	2.5	3.5	6	kΩ
Input turn-on threshold voltage		V _{IN(T+)}	1.7		3.2	V
Input turn-off threshold voltage		V _{IN(T-)}	1.5			V
Input threshold hysteresis	$\Delta V_{\rm IN(T)}$		0.5		V	
Off state input current	$V_{\rm IN} = 0.4$ V:	I _{IN(off)}	1		50	μA
On state input current	$V_{\rm IN} = 5$ V:	I _{IN(on)}	20	50	90	μA
Delay time for status with open load after switch off; (see diagram on page 13)		t _{d(ST OL4)}	100	520	900	μs
Status invalid after positive input slope		<i>t</i> _{d(ST)}			500	μs
(open load)						
Status output (open drain)						
Zener limit voltage	<i>I</i> _{ST} = +1.6 mA:	$V_{\rm ST(high)}$	5.4	6.1		V
ST low voltage	<i>I</i> _{ST} = +1.6 mA:	V _{ST(low)}			0.4	

 $^{^{\}rm 15)}\,$ If ground resistors $\rm R_{GND}$ are used, add the voltage drop across these resistors.



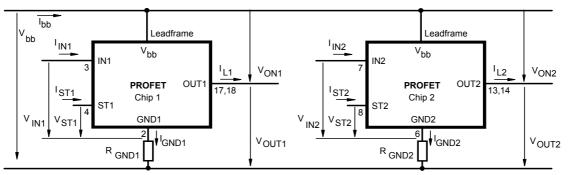
Truth Table

Channel 1	Input 1	Output 1	Status 1
Channel 2	Input 2	Output 2	Status 2
	level	level	BTS 728L2
Normal	L	L	Н
operation	н	н	н
Open load	L	Z	Н
-	н	н	L
Overtem-	L	L	Н
perature	Н	L	L

L = "Low" LevelX = don't careZ = high impedance, potential depends on external circuitH = "High" LevelStatus signal valid after the time delay shown in the timing diagrams

Parallel switching of channel 1 and 2 is easily possible by connecting the inputs and outputs in parallel. The status outputs ST1 and ST2 have to be configured as a 'Wired OR' function with a single pull-up resistor.

Terms



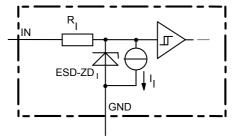
Leadframe (V_{bb}) is connected to pin 1,10,11,12,15,16,19,20

External R_{GND} optional; two resistors R_{GND1}, R_{GND2} = 150 Ω or a single resistor R_{GND} = 75 Ω for reverse battery protection up to the max. operating voltage.



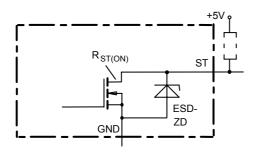
BTS 728 L2

Input circuit (ESD protection), IN1 or IN2



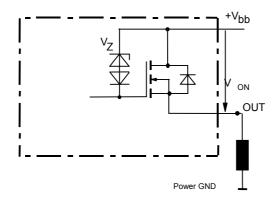
The use of ESD zener diodes as voltage clamp at DC conditions is not recommended.

Status output, ST1 or ST2



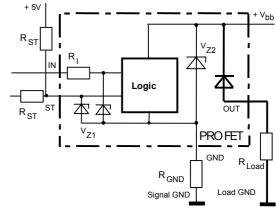
ESD-Zener diode: 6.1 V typ., max 5.0 mA; $R_{ST(ON)}$ < 375 Ω at 1.6 mA. The use of ESD zener diodes as voltage clamp at DC conditions is not recommended.

Inductive and overvoltage output clamp, OUT1 or OUT2



VON clamped to VON(CL) = 47 V typ.

Overvolt. and reverse batt. protection

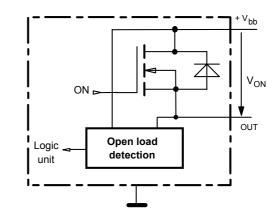


 $V_{Z1} = 6.1 \text{ V typ.}, V_{Z2} = 47 \text{ V typ.}, R_{GND} = 150 \Omega, R_{ST} = 15 \text{ k}\Omega, R_{I} = 3.5 \text{ k}\Omega \text{ typ.}$

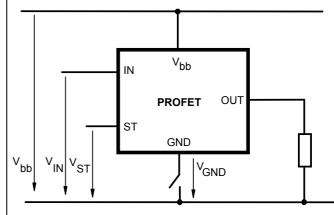
In case of reverse battery the load current has to be limited by the load. Temperature protection is not active

Open-load detection OUT1 or OUT2

ON-state diagnostic Open load, if $V_{ON} < R_{ON} \cdot I_{L(OL)}$; IN high



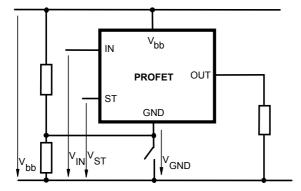
GND disconnect



Any kind of load. In case of IN = high is $V_{OUT} \approx V_{IN} \cdot V_{IN(T+)}$. Due to $V_{GND} > 0$, no V_{ST} = low signal available.

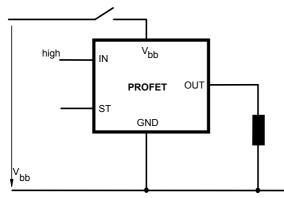


GND disconnect with GND pull up



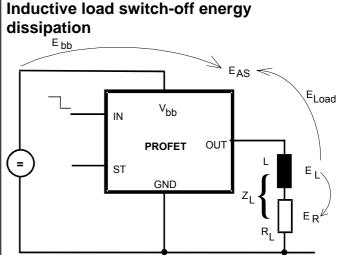
Any kind of load. If $V_{GND} > V_{IN} - V_{IN(T+)}$ device stays off Due to $V_{GND} > 0$, no $V_{ST} =$ low signal available.

$V_{bb}\xspace$ disconnect with energized inductive load



For inductive load currents up to the limits defined by Z_L (max. ratings and diagram on page 9) each switch is protected against loss of V_{bb} .

Consider at your PCB layout that in the case of Vbb disconnection with energized inductive load all the load current flows through the GND connection.



Energy stored in load inductance:

$$E_{\rm L} = \frac{1}{2} \cdot {\rm L} \cdot {\rm I}_{\rm L}^2$$

While demagnetizing load inductance, the energy dissipated in PROFET is

 $E_{AS} = E_{bb} + E_L - E_R = V_{ON(CL)} \cdot i_L(t) dt,$

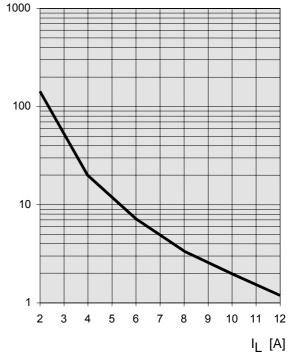
with an approximate solution for $R_L > 0 \Omega$:

$$E_{\text{AS}} = \frac{I_{\text{L}} \cdot L}{2 \cdot R_{\text{L}}} (V_{\text{bb}} + |V_{\text{OUT}(\text{CL})}|) ln (1 + \frac{I_{\text{L}} \cdot R_{\text{L}}}{|V_{\text{OUT}(\text{CL})}|})$$

Maximum allowable load inductance for a single switch off (one channel)⁴⁾

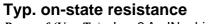
$$L = f(I_L)$$
; $T_{j,start} = 150^{\circ}C$, $V_{bb} = 12 V$, $R_L = 0 \Omega$

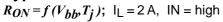
Z_L [mH]



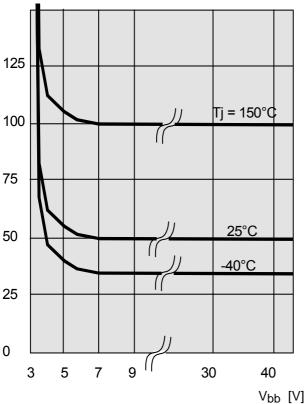


BTS 728 L2

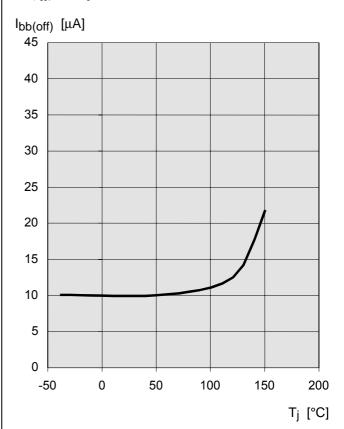








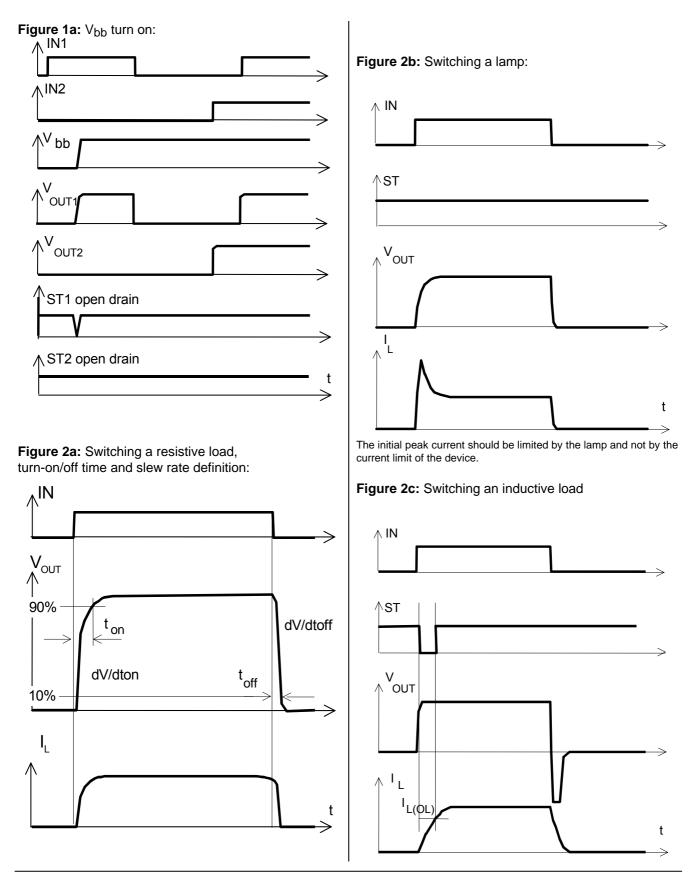
Typ. standby current $I_{bb(off)} = f(T_j)$; $V_{bb} = 9...34$ V, IN1,2 = low





Timing diagrams

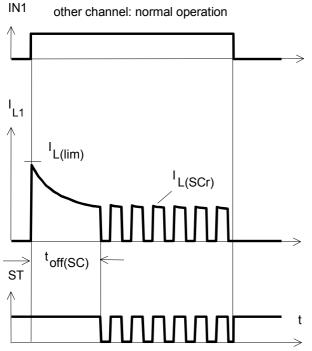
Both channels are symmetric and consequently the diagrams are valid for channel 1 and channel 2





 $^{\ast})$ if the time constant of load is too large, open-load-status may occur

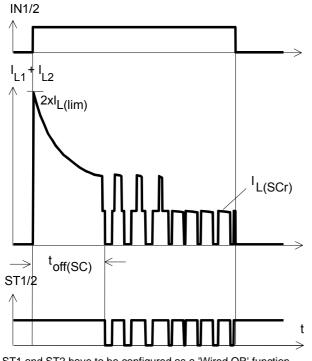
Figure 3a: Turn on into short circuit: shut down by overtemperature, restart by cooling



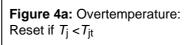
Heating up of the chip may require several milliseconds, depending on external conditions

Figure 3b: Turn on into short circuit:

shut down by overtemperature, restart by cooling (two parallel switched channels 1 and 2)



ST1 and ST2 have to be configured as a 'Wired OR' function ST1/2 with a single pull-up resistor.



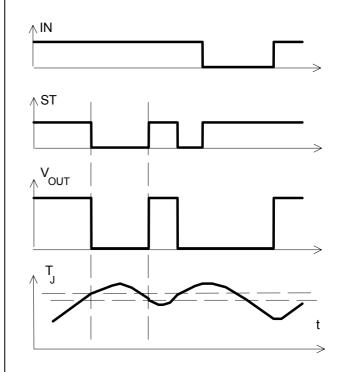


Figure 5a: Open load: detection in ON-state, open load occurs in on-state

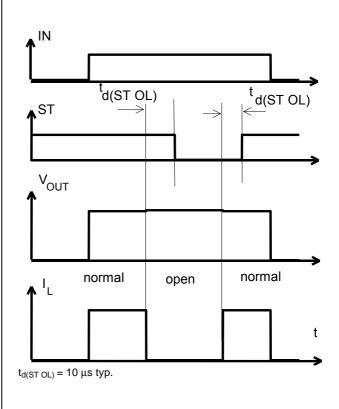
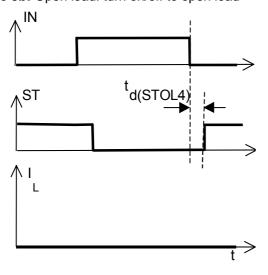




Figure 5b: Open load: turn on/off to open load



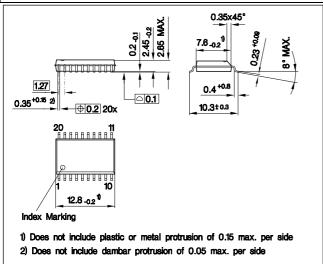


Package and Ordering Code

Standard: P-DSO-20-9

Sales Code	BTS 728 L2	
Ordering Code	Q67060-S7014-A2	

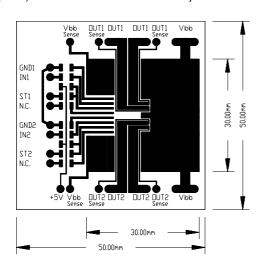
All dimensions in millimetres



Definition of soldering point with temperature T_s : upper side of solder edge of device pin 15.



Printed circuit board (FR4, 1.5mm thick, one layer 70 μ m, 6cm² active heatsink area) as a reference for max. power dissipation P_{tot}, nominal load current I_{L(NOM)} and thermal resistance R_{thia}



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